

# CMPA2060035F

35 W, 2000 - 6000 MHz, GaN MMIC Power Amplifier

Cree's CMPA2060035F is a gallium nitride (GaN) High Electron Mobility Transistor (HEMT) based monolithic microwave integrated circuit (MMIC). GaN has superior properties compared to silicon or gallium arsenide, including higher breakdown voltage, higher saturated electron drift velocity and higher thermal conductivity. GaN HEMTs also offer greater power density and wider bandwidths compared to Si and GaAs transistors. This MMIC contains a two-stage reactively matched amplifier enabling very wide bandwidths to be achieved in a small footprint screw-down package featuring a Copper-Tungsten heat-sink.



PN: CMPA2060035F Package Type: 440219

#### Typical Performance Over 2.0-6.0 GHz (T<sub>c</sub> = 25°C)

Parameter	2.0 GHz	4.0 GHz	6.0 GHz	Units
Small Signal Gain	25.6	28.5	26.8	dB
Output Power <sup>1</sup>	27.4	54	37	W
Power Gain <sup>1</sup>	17.4	20.3	18.7	dB
Power Added Efficiency <sup>1</sup>	33	47.2	34.2	%

Note<sup>1</sup>:  $V_{DD}$  = 32 V,  $I_{DQ}$  = 1.2 A,  $P_{IN}$  = 27 dBm. All data tested CW

#### Features

- 28 dB Small Signal Gain
- 35 W Typical P<sub>SAT</sub>
- Operation up to 32 V
- High Breakdown Voltage
- High Temperature Operation

#### **Applications**

- Ultra Broadband Amplifiers
- Fiber Drivers
- Test Instrumentation
- EMC Amplifier Drivers



Figure 1.

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## Absolute Maximum Ratings (not simultaneous) at 25°C

Parameter	Symbol	Rating	Units	Conditions
Drain-source Voltage	V <sub>DSS</sub>	84	VDC	
Gate-source Voltage	V <sub>gs</sub>	-10, +2	VDC	
Storage Temperature	T <sub>stg</sub>	-65, +150	°C	
Operating Junction Temperature	Tj	225	°C	
Forward Gate Current	Ι <sub>G</sub>	16	mA	
Screw Torque	Т	40	in-oz	
Thermal Resistance, Junction to Case	$R_{_{ ext{ hetaJC}}}$	1.67	°C/W	85 °C, P <sub>DISS</sub> = 65 W, CW
Case Operating Temperature	T <sub>c</sub>	-40, +115	°C	

# Electrical Characteristics (Frequency = 2.0 GHz to 6.0 GHz unless otherwise stated; $T_c = 25^{\circ}C$ )

Characteristics	Symbol	Min.	Тур.	Max.	Units	Conditions
DC Characteristics <sup>1,2</sup>						
Gate Threshold Voltage	V <sub>(GS)TH</sub>	-3.6	-3.1	-2.4	V	$V_{_{DS}}$ = 10 V, I $_{_{D}}$ = 16.8 mA
Gate Quiescent Voltage	V <sub>(GS)Q</sub>	-	-2.7	-	VDC	$V_{_{DD}}$ = 28 V, I $_{_{D}}$ = 1.2 A
Drain-Source Breakdown Voltage	$V_{\rm BD}$	84	-	-	V	$V_{_{\mathrm{GS}}}$ = -8 V, I $_{_{\mathrm{D}}}$ = 16.8 mA
Saturated Drain Current <sup>1</sup>	I <sub>DC</sub>	12.6	15.1	-	А	$V_{_{ m DS}}$ = 6.0 V, $V_{_{ m GS}}$ = 2.0 V
RF Characteristics <sup>3,4,5</sup>						
Small Signal Gain	S21	-	28.8	-	dB	$V_{_{\rm DD}}$ = 32 V, $I_{_{\rm DQ}}$ = 1.2 A, $P_{_{\rm IN}}$ = -30 dBm
Input Return Loss	S11	-	-10.7	-	dB	$V_{_{\rm DD}}$ = 32 V, $I_{_{\rm DQ}}$ = 1.2 A, $P_{_{\rm IN}}$ = -30 dBm
Output Return Loss	S22	-	-12.5	-	dB	$V_{_{\rm DD}}$ = 32 V, $I_{_{\rm DQ}}$ = 1.2 A, $P_{_{\rm IN}}$ = -30 dBm
Output Power,	P <sub>out</sub>	-	27.4	-	W	$V_{_{\rm DD}}$ = 32 V, I $_{_{\rm DQ}}$ = 1.2 A, Freq = 2.0 GHz
Output Power <sub>2</sub>	P <sub>out</sub>	-	54	-	W	$V_{_{\rm DD}}$ = 32 V, I $_{_{\rm DQ}}$ = 1.2 A, Freq = 4.0 GHz
Output Power <sub>3</sub>	P <sub>out</sub>	-	37	-	W	$V_{_{\rm DD}}$ = 32 V, I $_{_{\rm DQ}}$ = 1.2 A, Freq = 6.0 GHz
Power Added Efficiency <sub>1</sub>	PAE	-	33.0	-	%	$V_{_{\rm DD}}$ = 32 V, I $_{_{\rm DQ}}$ = 1.2 A, Freq = 2.0 GHz
Power Added Efficiency <sub>2</sub>	PAE	-	47.2	-	%	$V_{_{\rm DD}}$ = 32 V, I $_{_{\rm DQ}}$ = 1.2 A, Freq = 4.0 GHz
Power Added Efficiency <sub>3</sub>	PAE	-	34.2	-	%	$V_{_{\rm DD}}$ = 32 V, I $_{_{\rm DQ}}$ = 1.2 A, Freq = 6.0 GHz
Power Gain <sub>1</sub>	G <sub>p</sub>	-	17.4	-	dB	$V_{_{\rm DD}}$ = 32 V, $I_{_{\rm DQ}}$ = 1.2 A, Freq = 2.0 GHz
Power Gain <sub>2</sub>	G <sub>p</sub>	-	20.3	-	dB	$V_{_{\rm DD}}$ = 32 V, I $_{_{\rm DQ}}$ = 1.2 A, Freq = 4.0 GHz
Power Gain <sub>3</sub>	G <sub>P</sub>	-	18.7	-	dB	$V_{_{\rm DD}}$ = 32 V, $I_{_{\rm DQ}}$ = 1.2 A, Freq = 6.0 GHz
Output Mismatch Stress	VSWR	-	-	5 : 1	Ψ	No damage at all phase angles, $V_{_{DD}}$ = 32 V, $I_{_{DQ}}$ = 1.2 A, $P_{_{IN}}$ = 27 dBm

Notes:

<sup>1</sup> Measured on-wafer prior to packaging

<sup>2</sup> Scaled from PCM data

<sup>3</sup> Measured in CMPA2060035F-AMP

 $^4$  Measured at P  $_{\rm IN}$  = 27 dBm

<sup>5</sup>Tested CW

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Cree, Inc. 4600 Silicon Drive Durham, North Carolina, USA 27703 USA Tel: +1.919.313.5300 Fax: +1.919.869.2733 www.cree.com/ff



#### **Typical Performance**



CMPA2060035F Output Power, Gain and PAE vs. Frequency  $V_{_{DD}}$  = 32 V,  $I_{_{DQ}}$  = 1.2 A,  $P_{_{IN}}$  = 27 dBm, CW



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#### CMPA2060035F CW Power Dissipation De-rating Curve



Note 1. Area exceeds Maximum Case Operating Temperature (See Page 2).

#### **Electrostatic Discharge (ESD) Classifications**

Parameter	Symbol	Class	Test Methodology
Human Body Model	HBM	1A (> 250 V)	JEDEC JESD22 A114-D
Charge Device Model	CDM	II (200 < 500 V)	JEDEC JESD22 C101-C

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#### CMPA2060035F-AMP Demonstration Amplifier Circuit Outline



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## CMPA2060035F-AMP Demonstration Amplifier Circuit Bill of Materials

Designator	Description	Qty
	РСВ	1
C5	CAP, 3.9 PF, 250V, 0805, ATC600F	1
C1, C3, C8, C11	CAP, 100,000 PF, 50V, 0805, 10%	4
C6	CAP, 10 UF, 20%, G CASE	1
C7	CAP, 33 UF, 20%, G CASE	2
C9, C10	CAP, 2200 PF, 100V, 0805, 10%	2
C2, C4	CAP, 22 PF, 50V, 10%	2
J1,J2	CONN, SMA, FLANGE, 4-HOLE	2
J3	DC CONN, HEADER RT>PLZ .1CEN LK 5POS	1
	2-56 SOC HD SCREW 1/4 SS	4
	#2 FLATWASHER	4
Q1	CMPA2060035F	1

## Product Dimensions CMPA2060035F (Package Type – 440219)



1. DIMENSIONING AND TOLERANICING PER ANSI Y14.5M, 1982.

2. CONTROLLING DIMENSION: INCH.

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3. ADHESIVE FROM LID MAY EXTEND A MAXIMUM OF 0.020' BEYOND EDGE OF LID.

4. LID MAY BE MISALIGNED TO THE BODY OF THE PACKAGE BY A MAXIMUM OF 0.008' IN ANY DIRECTION. 5. ALL PLATED SURFACES ARE NI/AU

	INCHES		MILLIM	NOTE	
DIM	MIN MAX		MIN	MAX	NOTE
Α	0.148	0.162	3.76	4.12	-
A1	0.066	0.076	1.67	1.93	-
A2	0.056	0.064	1.42	1.63	-
b	0.0	22	0.56		-
b1	0.0	13	0.33		x4
b2	0.0	10	0.	25	-
с	0.0	02	0.05		x2
D	0.495	0.505	12.57	12.83	-
D1	0.403	0.413	10.23	10.49	-
D2	0.4	08	10.36		-
D3	0.243	0.253	6.17	6.43	-
E	0.495	0.505	12.57	12.83	-
E1	0.475	0.485	12.06	12.32	-
E2	0.3	20	8.13		-
E3	0.155	0.165	3.93	4.19	-
E4	0.105	0.115	2.66	2.92	-
e	0.0	46	1.17		x4
f	0.005		0.127		x6
f1	0.100	-	2.54	-	x6
f2	0.010		.254		x6
f3	0.022		.559		×6
L	0.044		1.12		x6
r	R0.046		R1.17		×4
r1	R0.080		R2.03		x4

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#### **Product Ordering Information**

Order Number	Description	Unit of Measure	Image
CMPA2060035F	GaN MMIC	Each	
CMPA2060035F-AMP	Test board with GaN MMIC installed	Each	

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